# Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Ke-Horng Chen	11/23/2011
Yu-Huei Lee	11/23/2011
Shih-Jung Wang	11/23/2011
Yao-Yi Yang	11/23/2011
Ying Hsi Lin	11/23/2011

#### RECEIVING PARTY DATA

Name:	REALTEK SEMICONDUCTOR CORP.	
Street Address:	2 Innovation Rd. II, Science Park	
City:	Hsinchu	
State/Country:	TAIWAN	

### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13304464

## CORRESPONDENCE DATA

Fax Number: (404)365-9532 Phone: 404-233-7000

Email: ipdocket@mmmlaw.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US

Mail.

Correspondent Name: MORRIS MANNING MARTIN LLP
Address Line 1: 3343 PEACHTREE ROAD, NE
Address Line 2: 1600 ATLANTA FINANCIAL CENTER

Address Line 4: ATLANTA, GEORGIA 30326

ATTORNEY DOCKET NUMBER:	21225-82638
NAME OF SUBMITTER:	Tim Tingkang Xia

### Total Attachments: 3

source=2122582638Assignment#page1.tif source=2122582638Assignment#page2.tif source=2122582638Assignment#page3.tif \$40.00

PATENT REEL: 027295 FRAME: 0491

#### ASSIGNMENT

WHEREAS, we/I, CHEN, KE-HORNG residing at 4F., No.2, Lane 133, Juguang Rd., Banqiao Dist., New Taipei City 22042, Taiwan (R.O.C.) a citizen of Taiwan, R.O.C.; LEE, YU-HUEI residing at 10F., No.65, Sanyang Rd., Sanchong Dist., New Taipei City 24161, Taiwan (R.O.C.) a citizen of Taiwan, R.O.C.; WANG, SHIH-JUNG residing at 3F., No.32, Lane 130, Sec. 3, Minquan E. Rd., Songshan Dist., Taipei City 10543, Taiwan (R.O.C.) a citizen of Taiwan, R.O.C.; YANG, YAO-YI residing at No.15-6, Toulun Ln., Lugang Township, Changhua County 50543, Taiwan (R.O.C.) a citizen of Taiwan, R.O.C.; LIN, YING HSI residing at No.23, Alley 1, Lane 30, Fuqun St., Xiangshan Dist., Hsinchu City 30067, Taiwan (R.O.C.) a citizen of Taiwan, R.O.C. (hereinafter "Applicants") have invented new and useful improvements for which we/I filed a U.S. patent application in the United States Patent and Trademark Office herewith, which is entitled:

SIDO POWER CONVERTER AND DRIVING METHOD THEREOF

and was assigned U.S. Serial No. 13/304,464.

AND WHEREAS, <u>REALTEK SEMICONDUCTOR CORP.</u> having an office and place of business at <u>2 INNOVATION Rd. II, SCIENCE PARK, HSINCHU, TAIWAN, R.O.C</u> (hereinafter "Assignee") is desirous of acquiring the entire right, title and interest in and to said inventions, improvements and application and in and to the Letters Patent to be obtained therefor;

NOW THEREFORE, to all whom it may concern, be it known that for and in consideration of the sum of One Dollar and other good and valuable considerations, the receipt and sufficiency whereof is hereby acknowledged, we/I have sold, assigned, and transferred, and by these presents do sell, assign and transfer unto said Assignee, its successors or assigns, the entire right, title and interest for all countries in and to all inventions and improvements disclosed in the aforesaid application, and in and to the application, all divisionals, continuations, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and in and to any and all applications which have been or shall be filed in any foreign countries for Letters Patent on the inventions and improvements, including an assignment of all rights under the provisions of the

PATENT REEL: 027295 FRAME: 0492 International Convention, and all Letters Patent of foreign countries which may be granted therefrom; and we/I do hereby authorize and request the Commissioner of Patents and Trademarks to issue any and all United States Letters Patent for the aforesaid inventions and improvements to the Assignee as the assignee of the entire right, title and interest in and to the same, for the use of the Assignee, its successors and assigns.

AND, for the consideration aforesaid, we/I do hereby agree that we/I and our/my executors and legal representatives will make, execute and deliver any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said Assignee, its successors and representatives all facts known to us/me relating to said improvements and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable more effectually to secure to and vest in said Assignee, its successors or assigns the entire right, title and interest in and to the improvements, inventions, applications, Letters Patent, rights, titles, benefits, privileges and advantages hereby sold, assigned and conveyed, or intended so to be.

AND, furthermore we/I covenant and agree with said Assignee, its successors and assigns, that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by us/me and that full right to convey the same as herein expressed is possessed by us/me.

We/I also authorize counsel for Applicant and/or Assignee to enter above the serial number of the application or other related information when it becomes available.

IN TESTIMONY WHEREOF, I have hereunto set my hand this ON NOV 2 3 2011

CHEN, KE-HORNG Chen

IN TESTIMONY WHEREOF, I have hereunto set my hand this ON NOV 2 3 2011.

LEE, YU-HUEI

IN TESTIMONY WHEREOF, I have hereunto set my hand this ON NOV 2 3 2011

SHIH-JUNG WANG

IN TESTIMONY WHEREOF, I have hereunto set my hand this ON NOV 2 3 2011.

YANG, YAO-YI

IN TESTIMONY WHEREOF, I have hereunto set my hand this ON NOV 2 3 2011

LIN, YING HS

PATENT REEL: 027295 FRAME: 0494

**RECORDED: 11/29/2011**